

## N-Channel Super Junction Power MOSFET IV

### General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

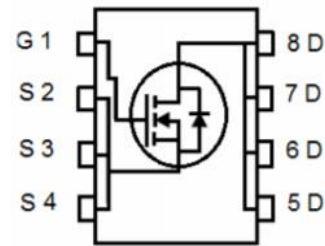
### Features

- Optimized body diode reverse recovery performance
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

$V_{DS\ min@T_{jmax}}$	710	V
$R_{DS(ON)TYP}$	60	mΩ
ID	45	A
Qg	65	nC



Schematic diagram

✧ Intrinsic fast-recovery body diode

### Package Marking And Ordering Information

Device	Device Package	Marking
NCE65NF068V	DFN8*8	NCE65NF068V

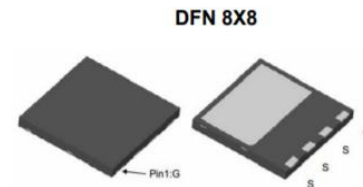


Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Drain-Source Voltage ( $V_{GS}=0V$ )	$V_{DS}$	650	V
Gate-Source Voltage ( $V_{DS}=0V$ ) AC ( $f>1\text{ Hz}$ )	$V_{GS}$	$\pm 30$	V
Gate-Source Voltage ( $V_{DS}=0V$ ) DC	$V_{GS}$	$\pm 20$	V
Continuous Drain Current at $T_c=25^\circ\text{C}$	$I_{D(DC)}$	45	A
Continuous Drain Current at $T_c=100^\circ\text{C}$	$I_{D(DC)}$	31.5	A
Pulsed drain current (Note 1)	$I_{DM(pluse)}$	135	A
Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	$P_D$	371	W
Derate above $25^\circ\text{C}$		2.47	W/ $^\circ\text{C}$
Single pulse avalanche energy (Note 2)	$E_{AS}$	400	mJ
Avalanche current (Note 1)	$I_{AS}$	10	A
Repetitive Avalanche energy, $t_{AR}$ limited by $T_{jmax}$ (Note 1)	$E_{AR}$	0.9	mJ
Drain Source voltage slope, $V_{DS} \leq 480\text{ V}$ ,	$dv/dt$	50	V/ns
Reverse diode $dv/dt$ , $V_{DS} \leq 480\text{ V}, I_{SD} < I_D$	$dv/dt$	50	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55...+175	$^\circ\text{C}$

\* limited by maximum junction temperature

**Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	0.40	$^{\circ}C/W$
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	$^{\circ}C/W$

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

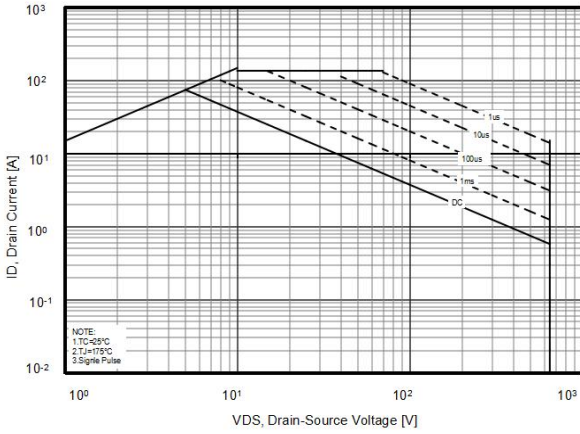
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>On/off states</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=1mA$	650			V
Zero Gate Voltage Drain Current(Tc=25°C)	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			10	$\mu A$
Zero Gate Voltage Drain Current(Tc=125°C)	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			300	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=500\mu A$	3.5	4	5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=23A$		64	72	m $\Omega$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=50V, V_{GS}=0V,$ $F=1.0MHz$		3900	4400	pF
Output Capacitance	$C_{oss}$			132		pF
Reverse Transfer Capacitance	$C_{rss}$			14		pF
Total Gate Charge	$Q_g$	$V_{DS}=480V, I_D=23A,$ $V_{GS}=10V$		65	70	nC
Gate-Source Charge	$Q_{gs}$			21		nC
Gate-Drain Charge	$Q_{gd}$			17		nC
Gate plateau voltage	$V_{gp}$			6.5		V
Intrinsic gate resistance	$R_G$	$f = 1 MHz$ open drain		3		$\Omega$
<b>Switching times</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=380V, I_D=23A,$ $R_G=1.7\Omega, V_{GS}=10V$		42		nS
Turn-on Rise Time	$t_r$			14		nS
Turn-Off Delay Time	$t_{d(off)}$			90		nS
Turn-Off Fall Time	$t_f$			12		nS
<b>Source- Drain Diode Characteristics</b>						
Source-drain current(Body Diode)	$I_{SD}$	$T_C=25^{\circ}C$			45	A
Pulsed Source-drain current(Body Diode)	$I_{SDM}$				135	A
Forward On Voltage	$V_{SD}$	$T_j=25^{\circ}C, I_{SD}=45A, V_{GS}=0V$		1.0	1.2	V
Reverse Recovery Time	$t_{rr}$	$T_j=25^{\circ}C, I_F=23A,$ $di/dt=100A/\mu s$		173		nS
Reverse Recovery Charge	$Q_{rr}$			1.13		$\mu C$
Peak Reverse Recovery Current	$I_{rrm}$			13		A

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

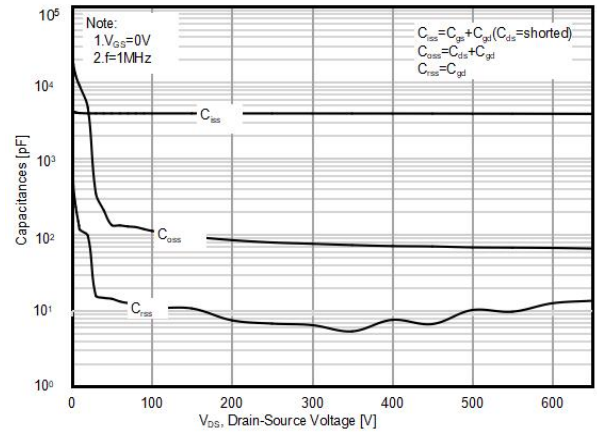
2.  $T_j=25^{\circ}C, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

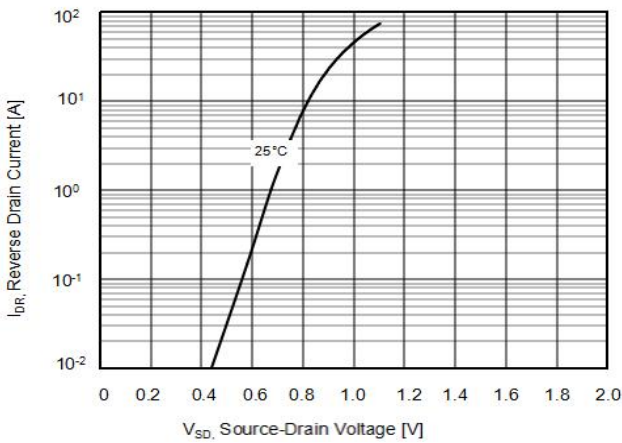
**Figure1. Safe operating area**



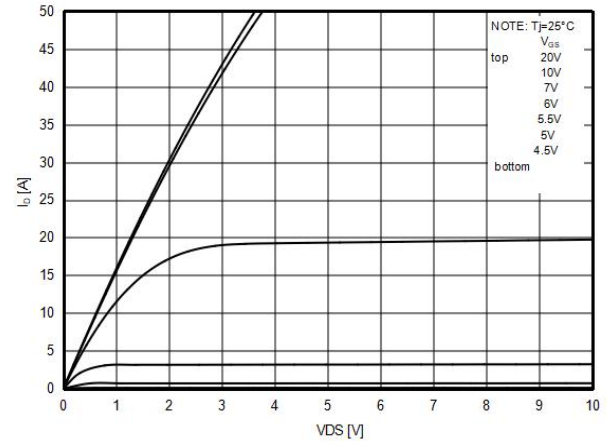
**Figure2. Capacitance**



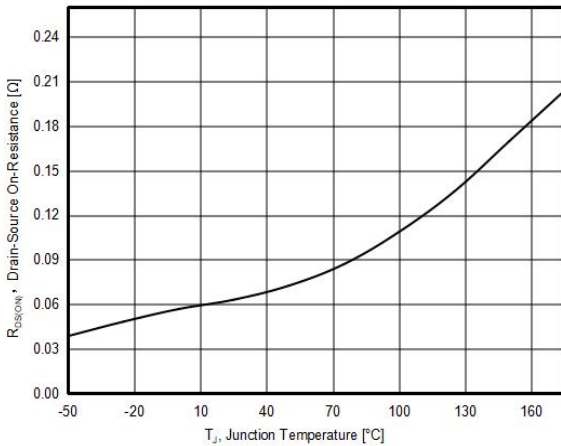
**Figure3. Source-Drain Diode Forward Voltage**



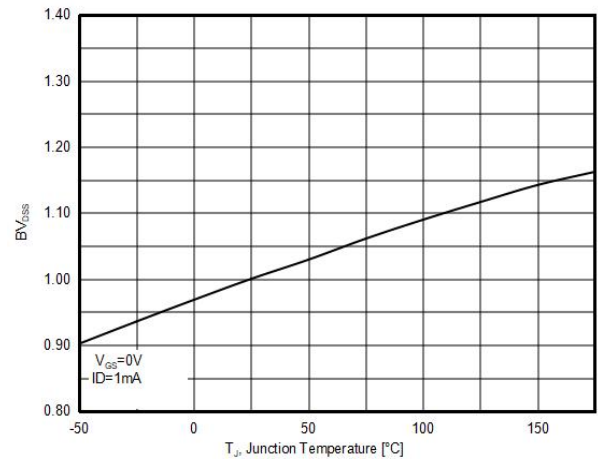
**Figure4. Output characteristics**



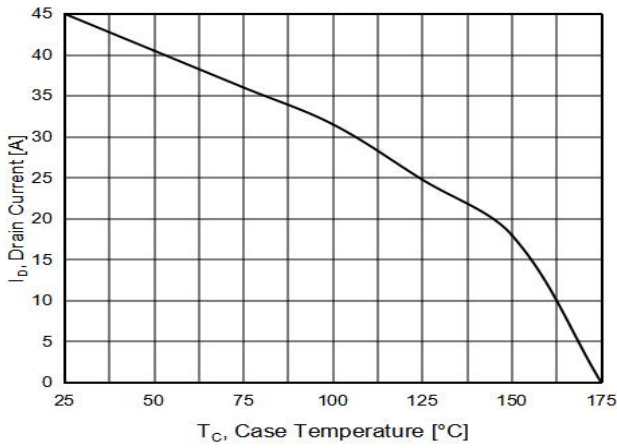
**Figure5.  $R_{DS(ON)}$  vs Junction Temperature**



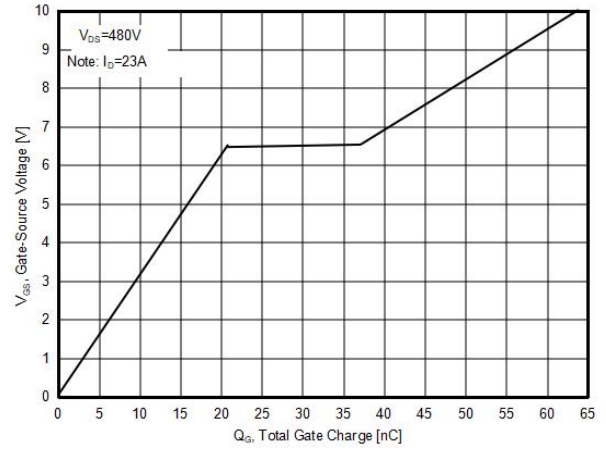
**Figure6.  $BV_{DSS}$  vs Junction Temperature**



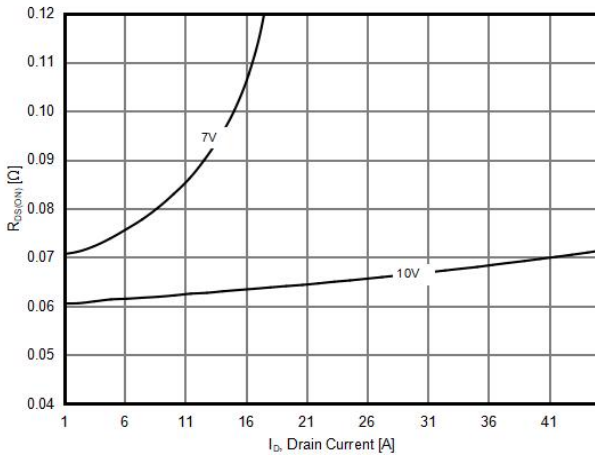
**Figure7. Maximum  $I_D$  vs Junction Temperature**



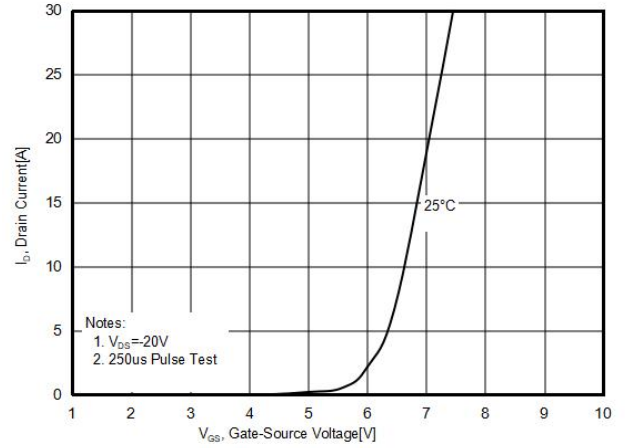
**Figure8. Gate charge waveforms**



**Figure9. Static drain-source on resistance**



**Figure10. Transfer characteristics**

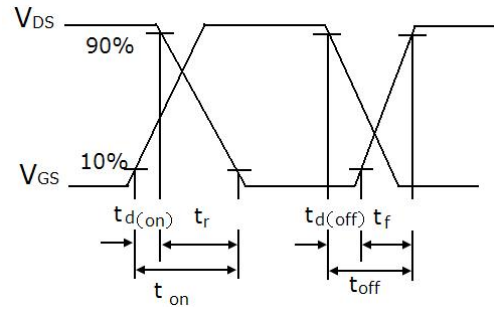


## Test circuit

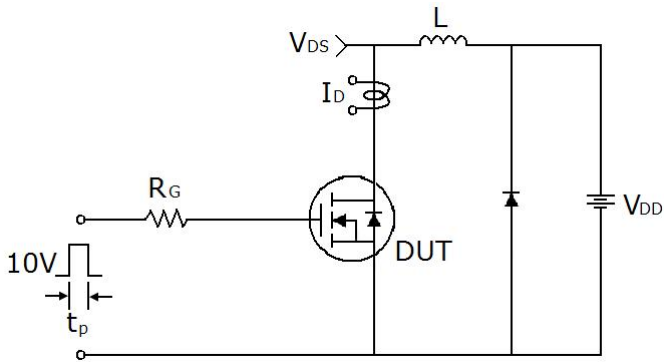
### 1) Gate charge test circuit & Waveform



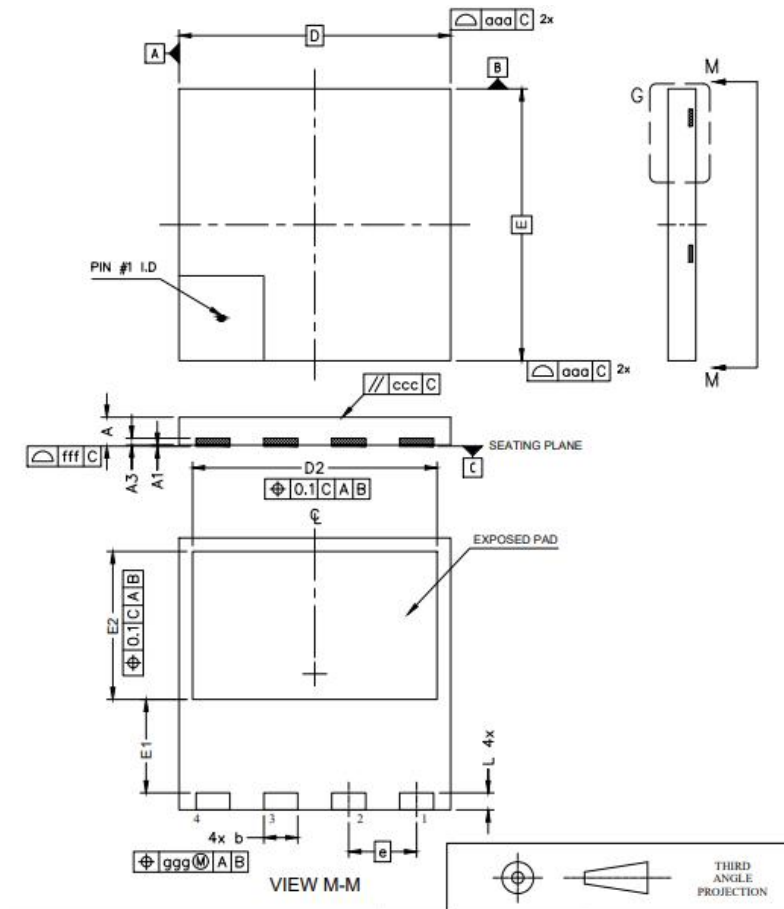
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## DFN8X8-B Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.75	0.95	0.030	0.037
A1	0.00	0.05	0.000	0.002
b	0.90	1.10	0.035	0.043
A3	0.10	0.30	0.004	0.012
D	7.90	8.10	0.311	0.319
E	7.90	8.10	0.311	0.319
D2	7.10	7.30	0.280	0.287
E1	2.65	2.85	0.104	0.112
E2	4.25	4.45	0.167	0.175
e	2.00 BSC		0.079 BSC	
L	0.40	0.60	0.016	0.024

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